

# Micro-systems for Scalable QKD Components Achievements & Progress

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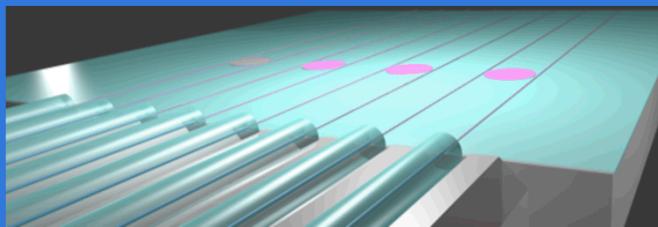
Ian Frank

Ed Bielejec

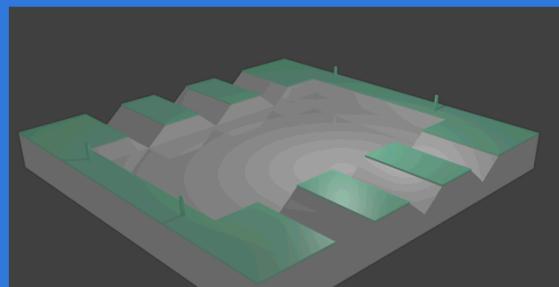
Jose Pacheco

# Sandia Efforts

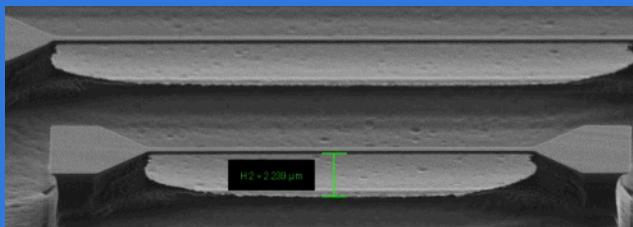
Demonstrate efficient (-1 dB) fiber – to – chip-to-fiber coupling, enabling quantum integration applications.



Develop simplified, scalable kinematic alignment techniques.



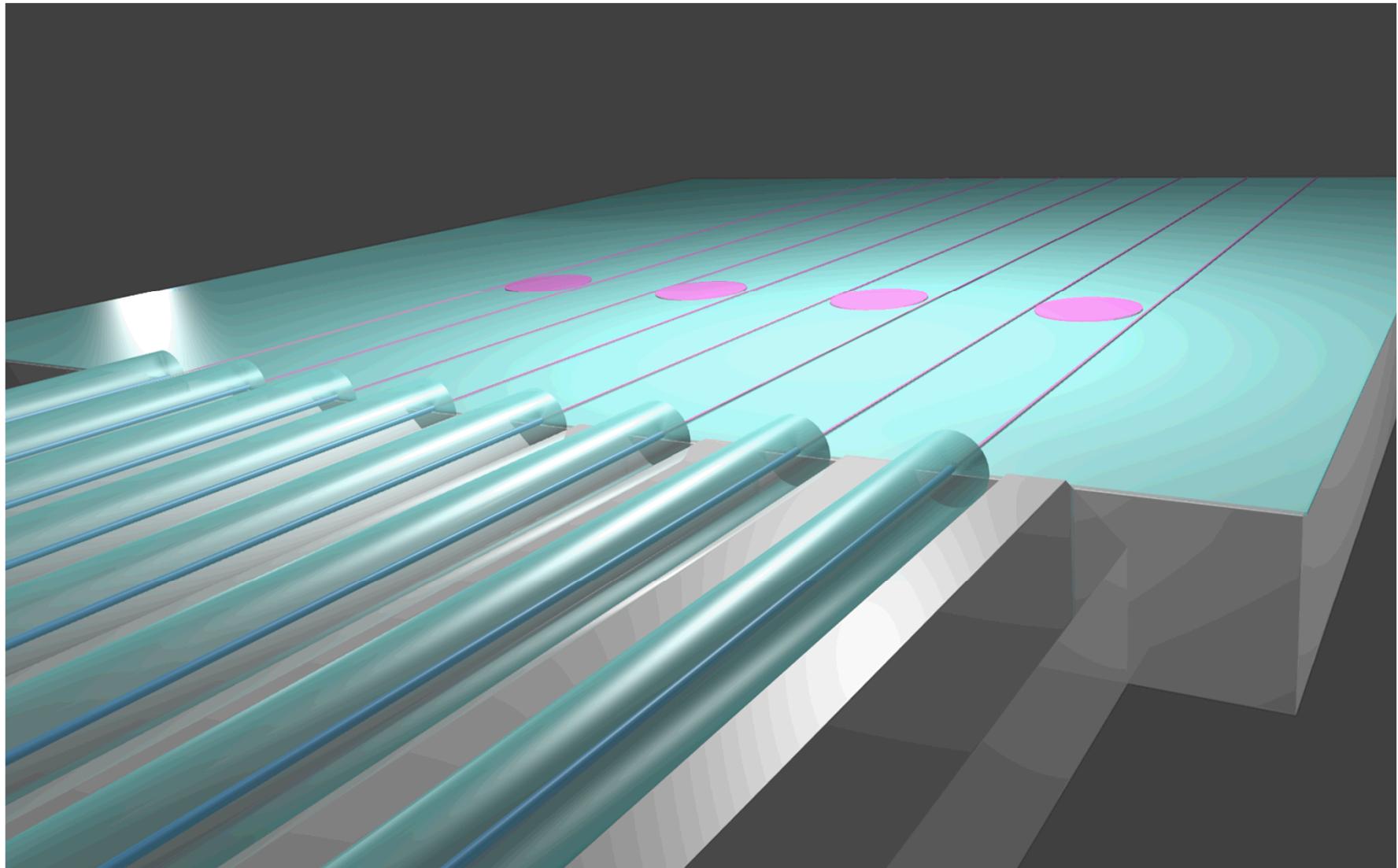
Develop targeted, deterministic ion implantation in diamond substrates.  
Supporting: Loncar, Englund, and Waks.



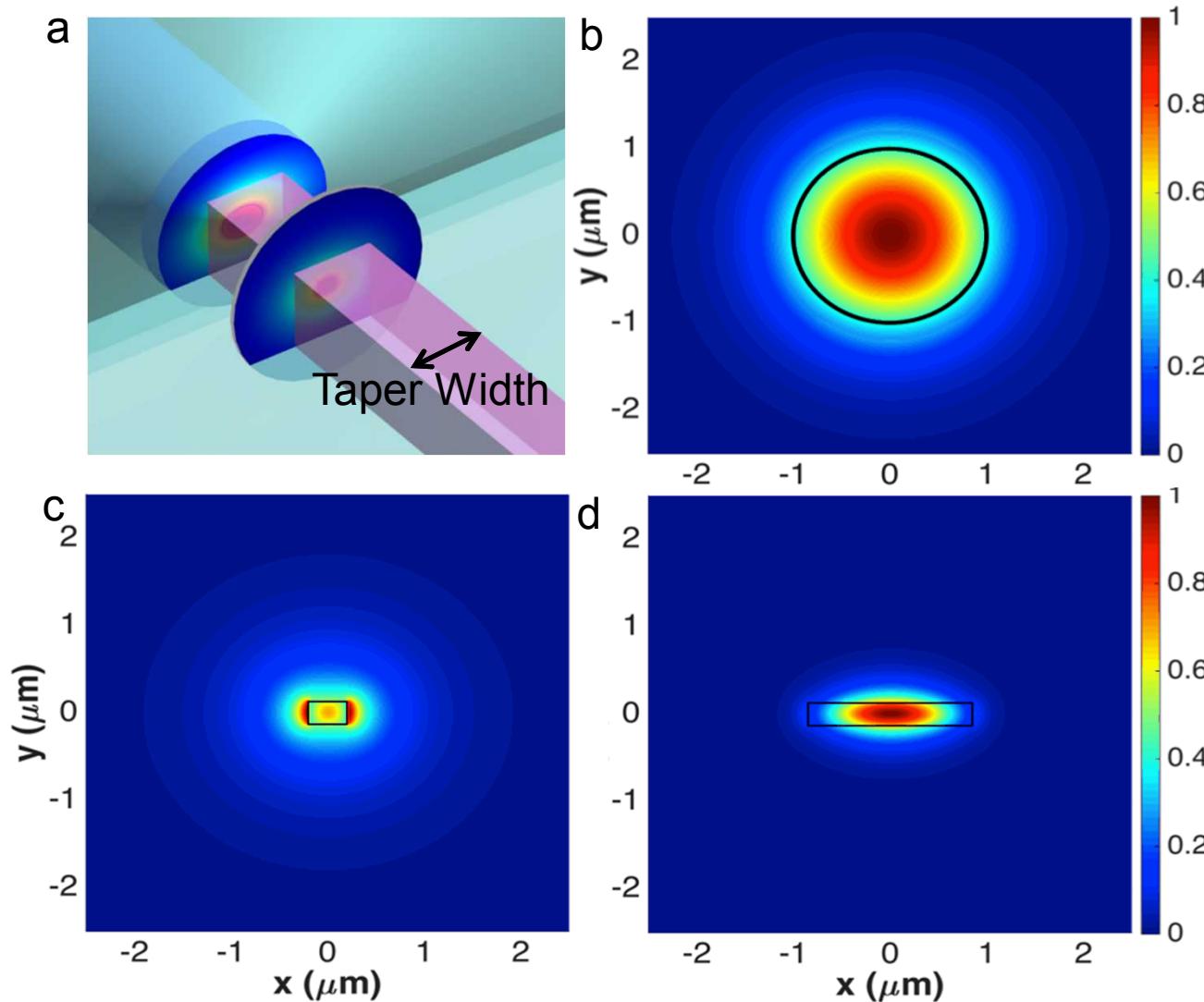
Deliver high quality, packaged, integrated resonators to Northwestern and UMBC teams.



# Efficient Fiber-to-chip Coupling

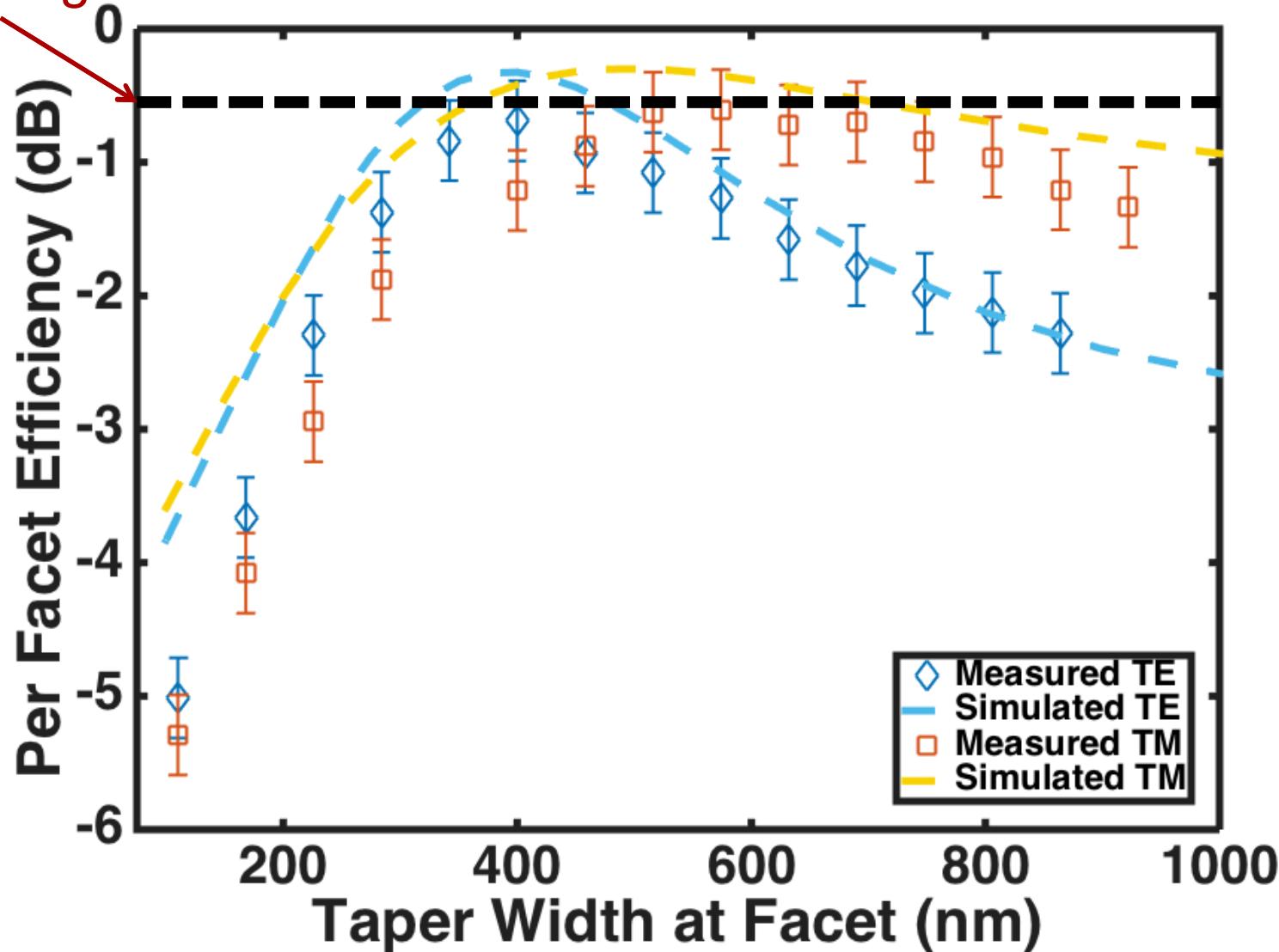


# The problem & solution

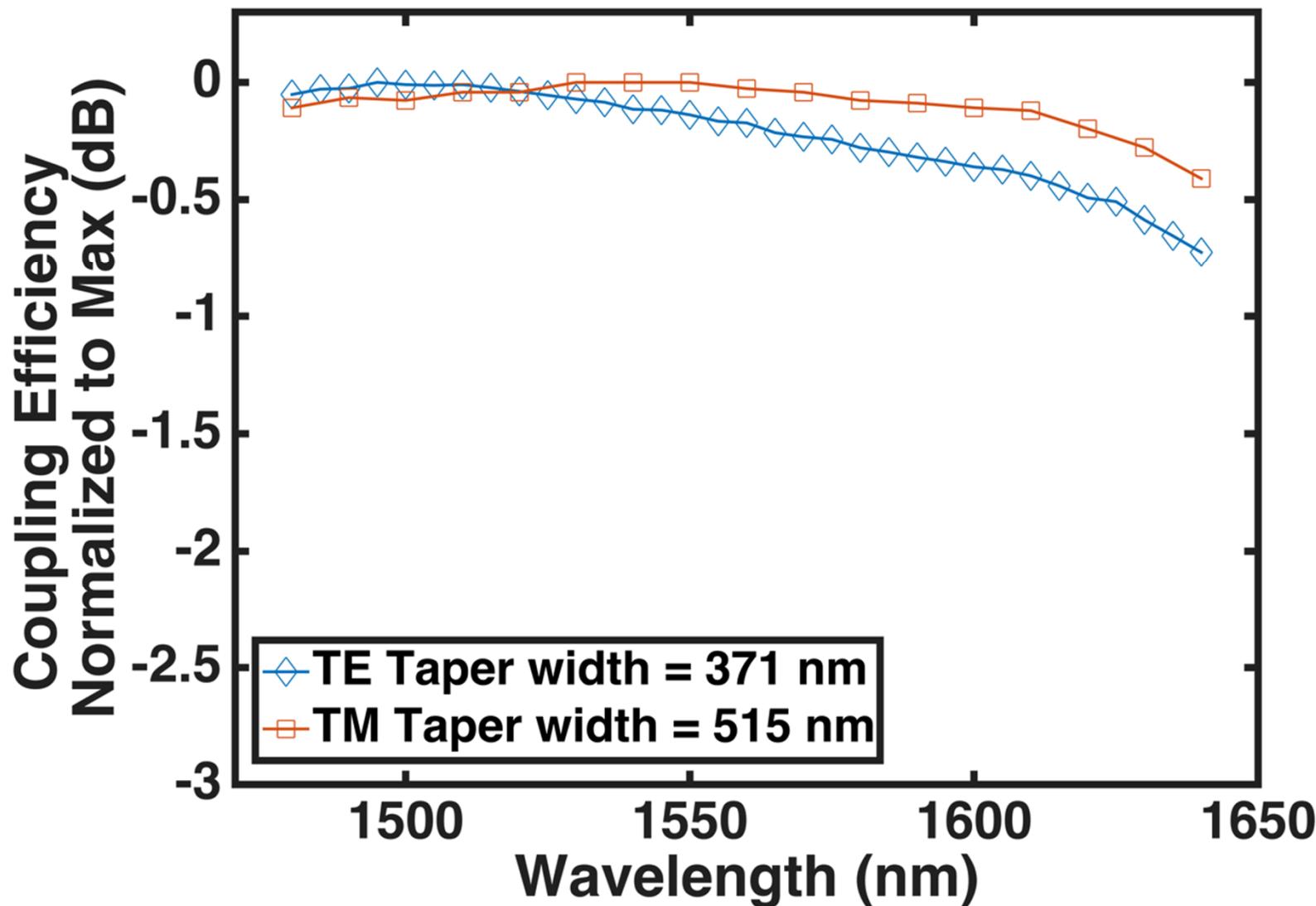


# Advances in Fiber-to-chip coupling

Program goal



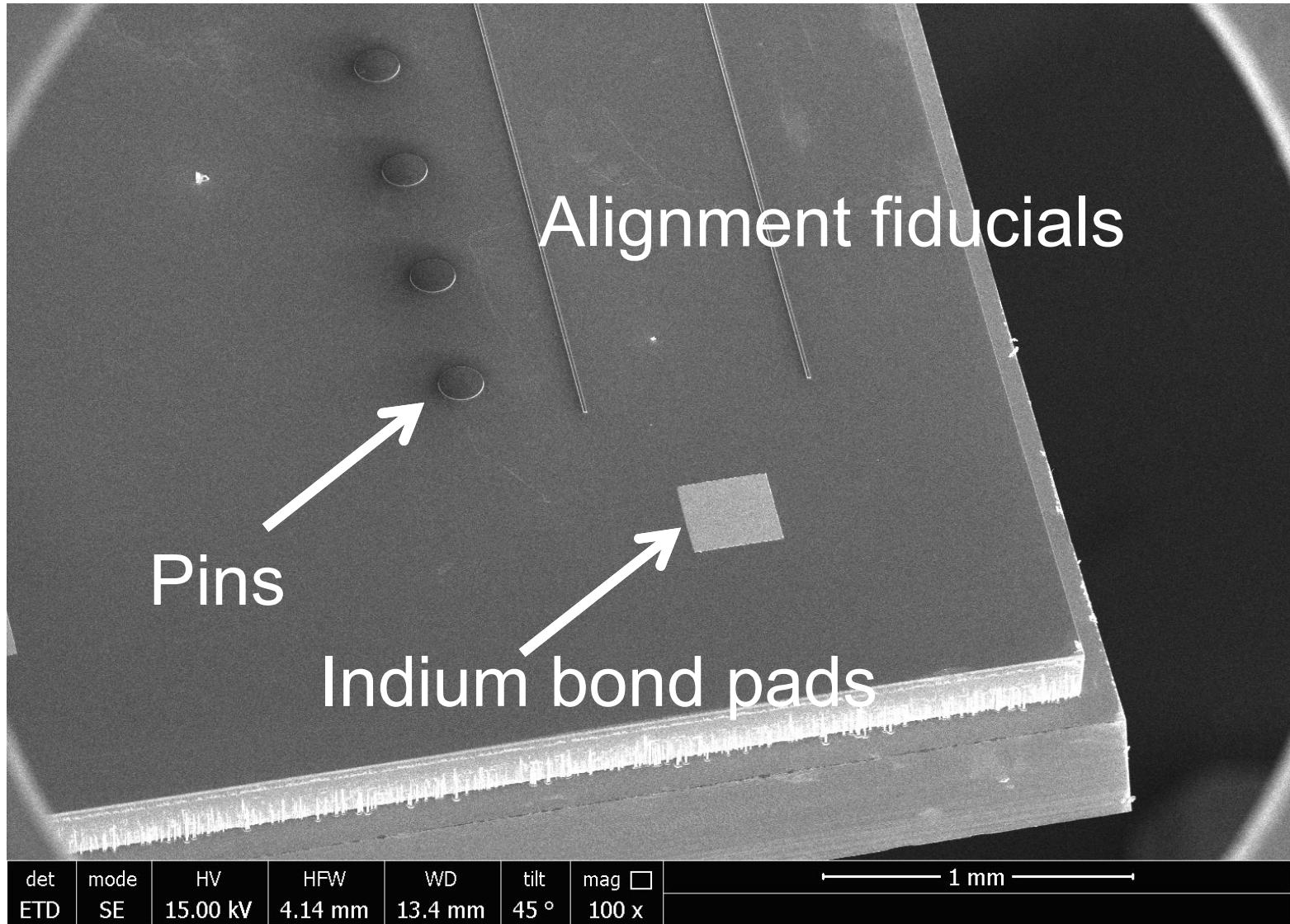
# Bandwidth and multiple facets



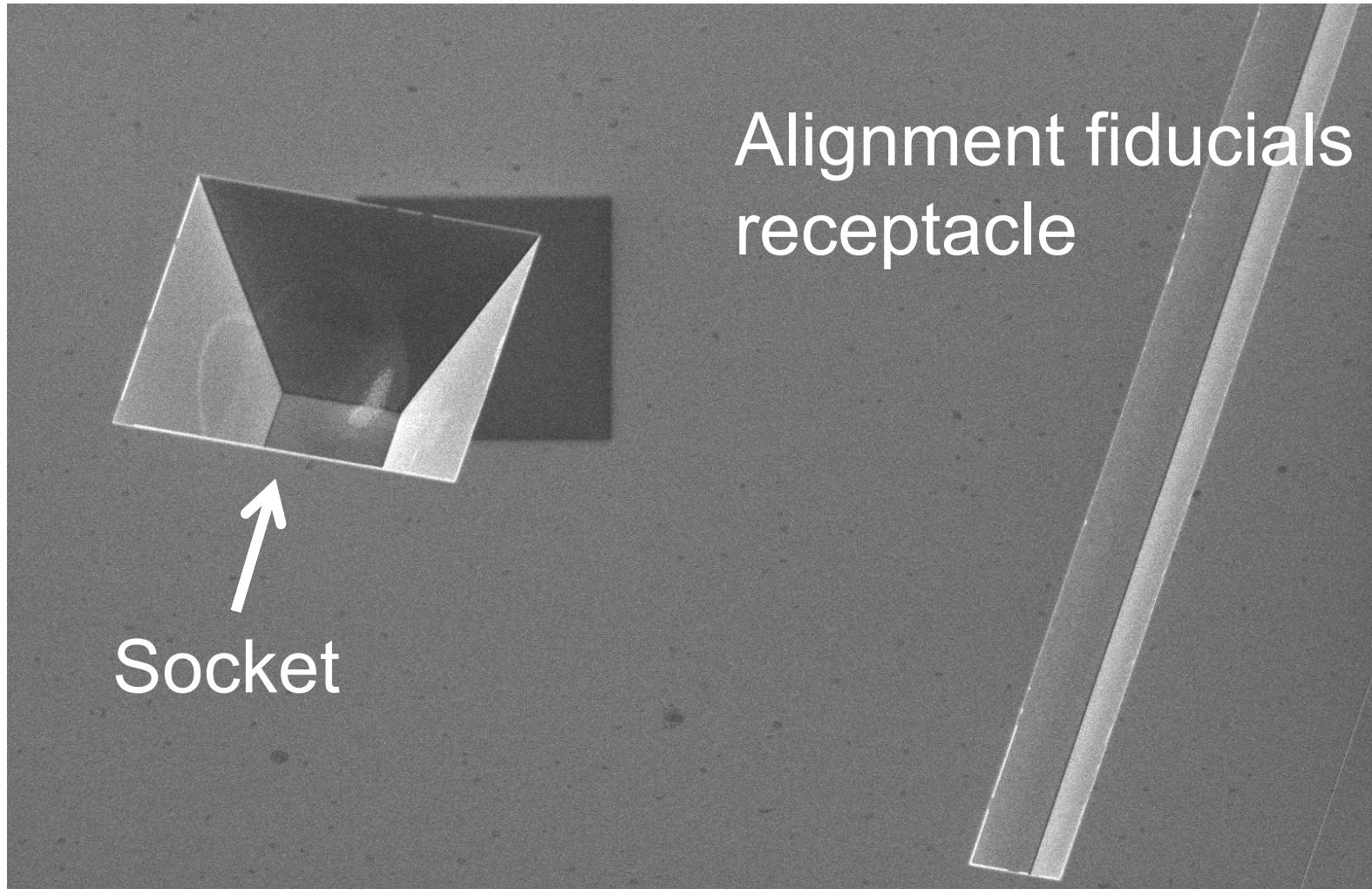
# Kinematic Alignment Efforts



# Our Components

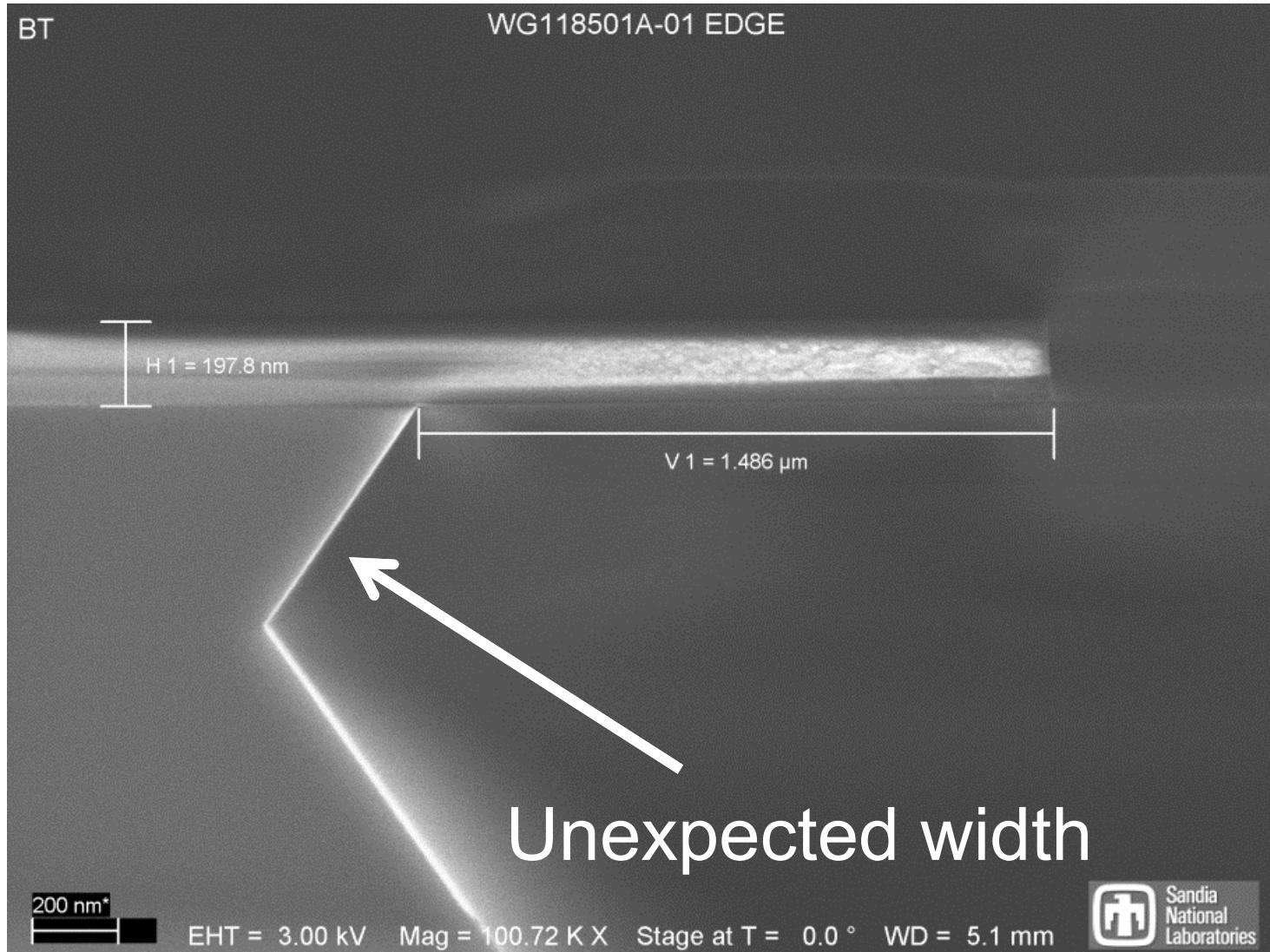


# Our components II

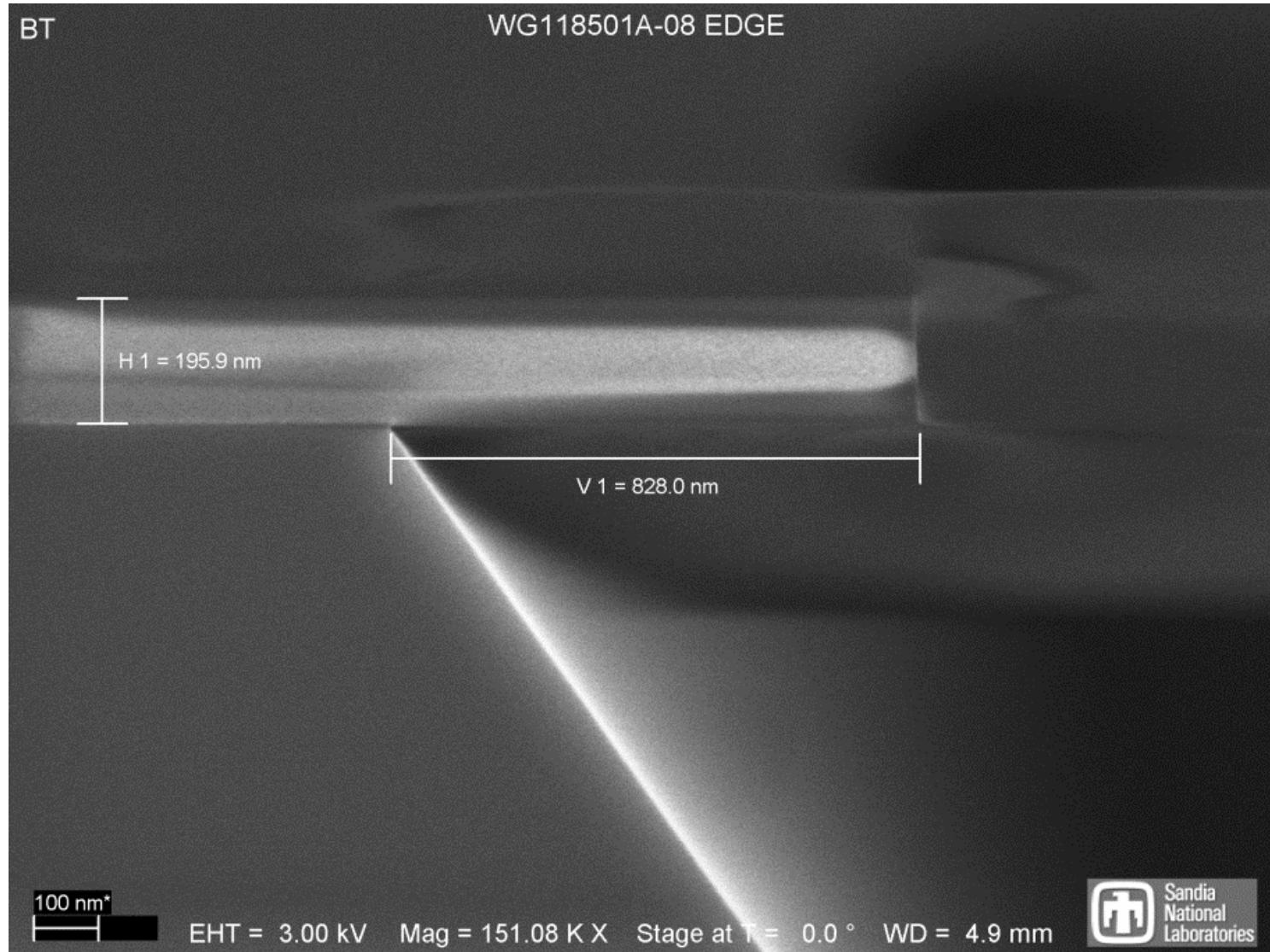


det	mode	HV	HFW	WD	tilt	mag	200 $\mu$ m
ETD	SE	15.00 kV	592 $\mu$ m	16.9 mm	45 °	350 x	

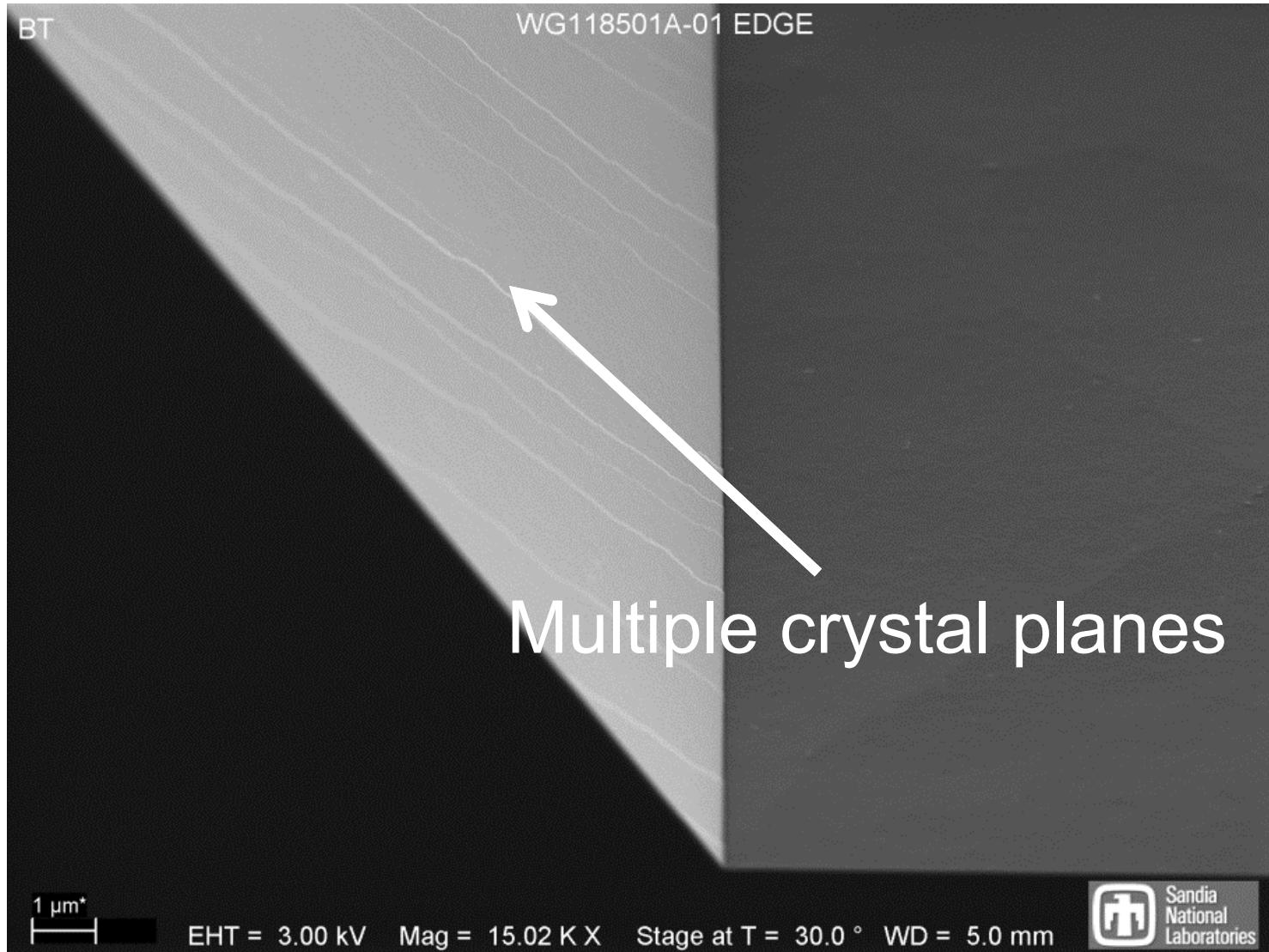
# An example of the fab challenges



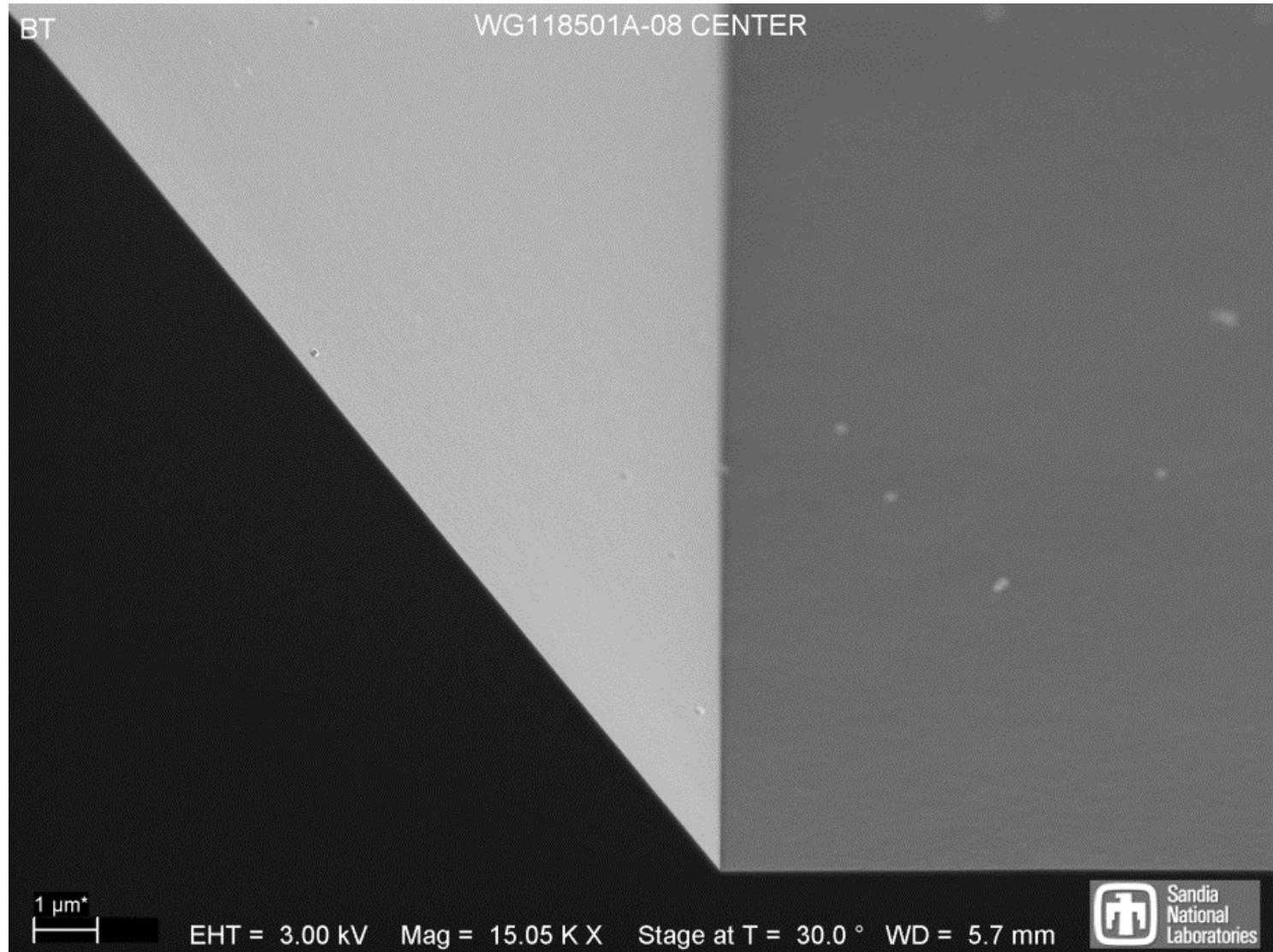
# An example of the fab challenges



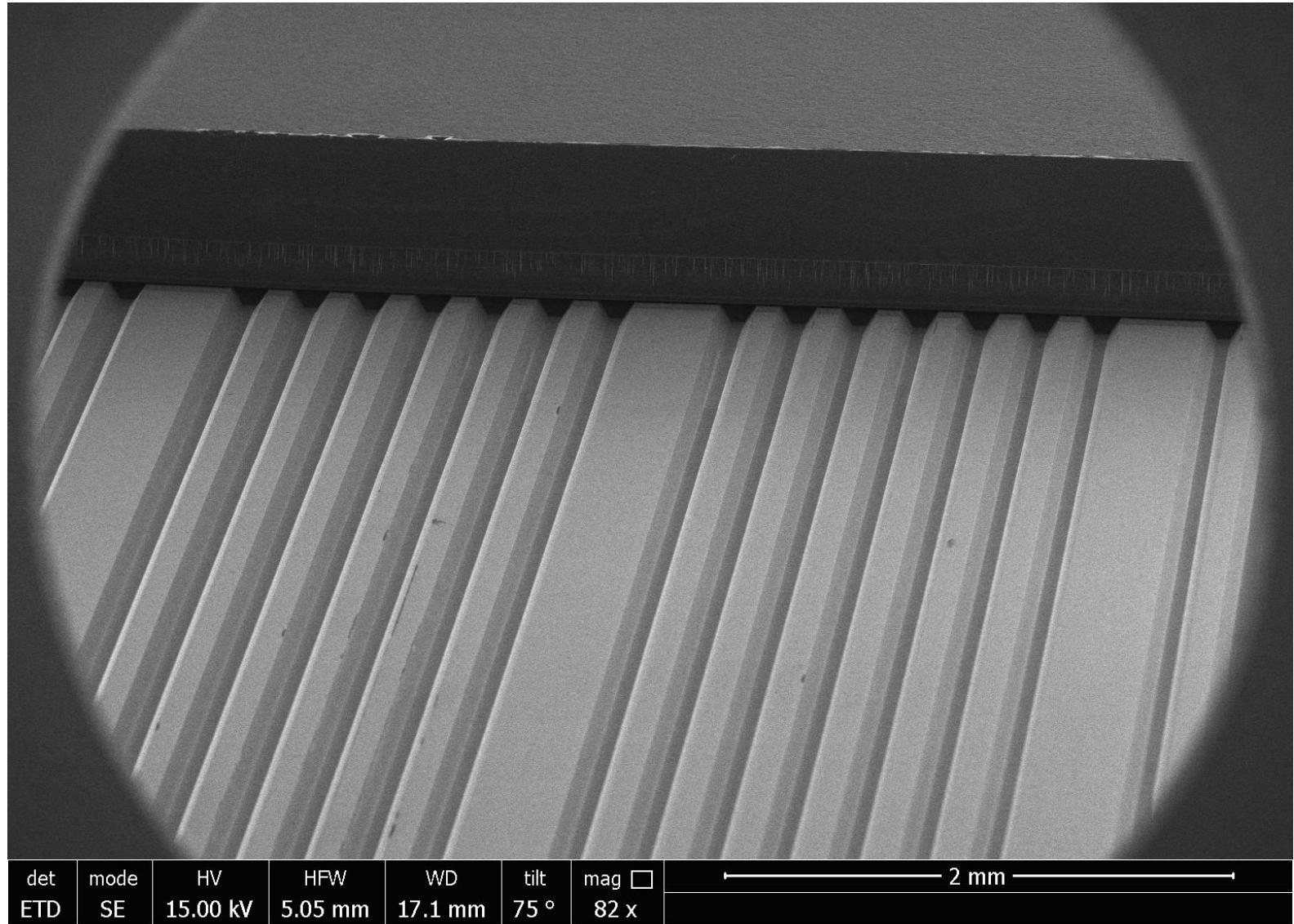
# An example of fab challenges



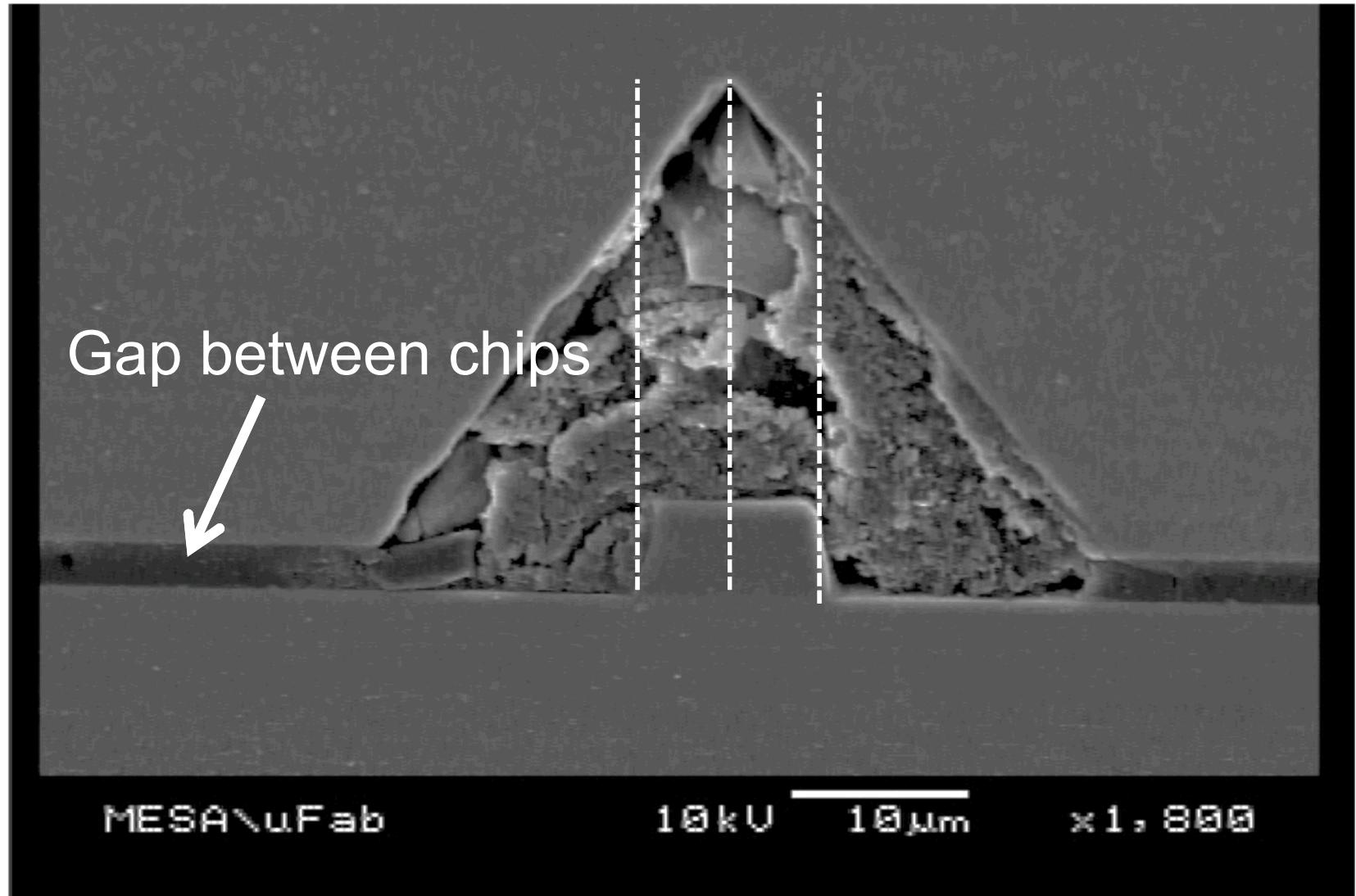
# An example of fab challenges



# Bonded Chips



# How close are we?

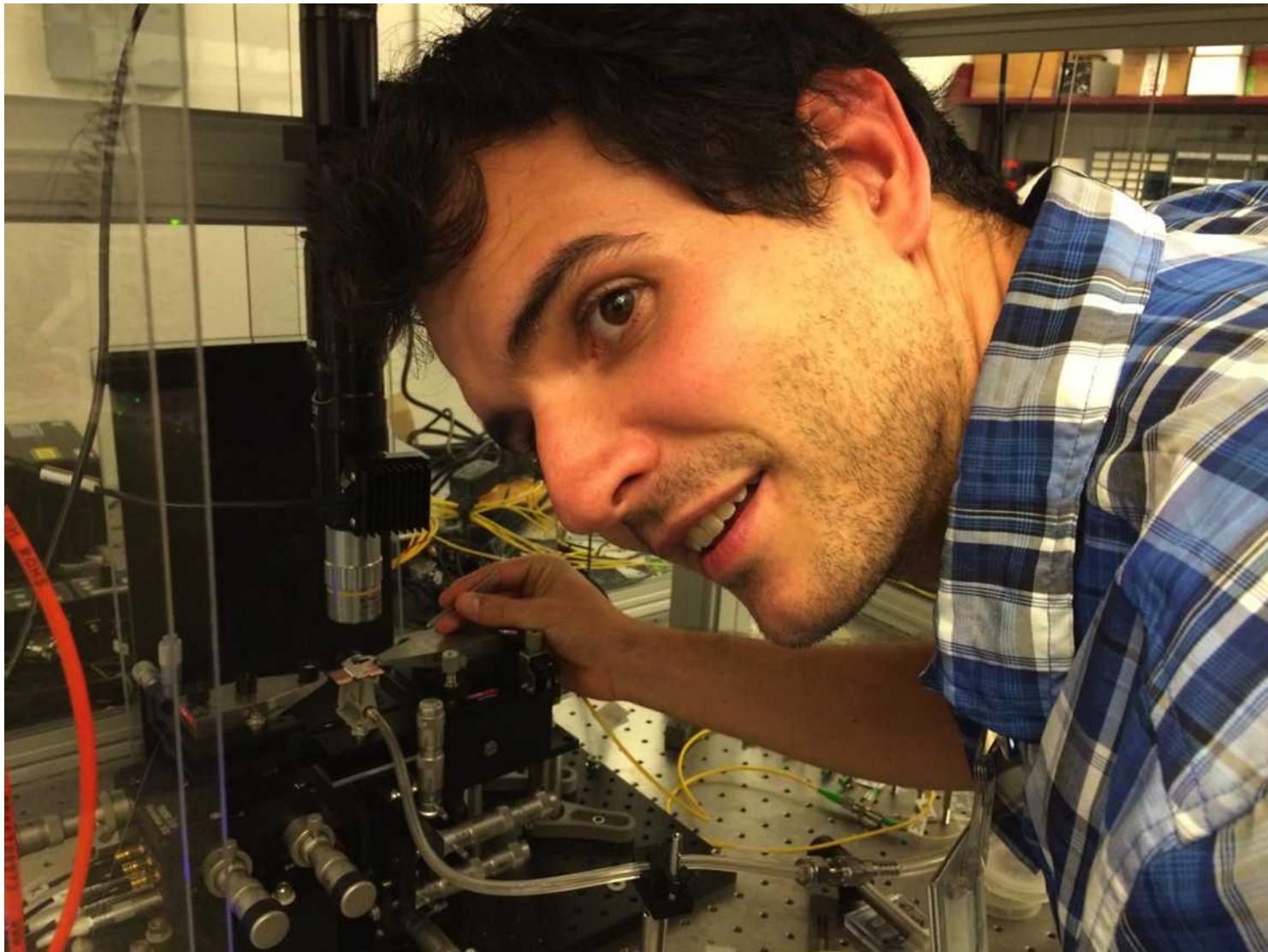


# Coupling with 1-axis micrometer

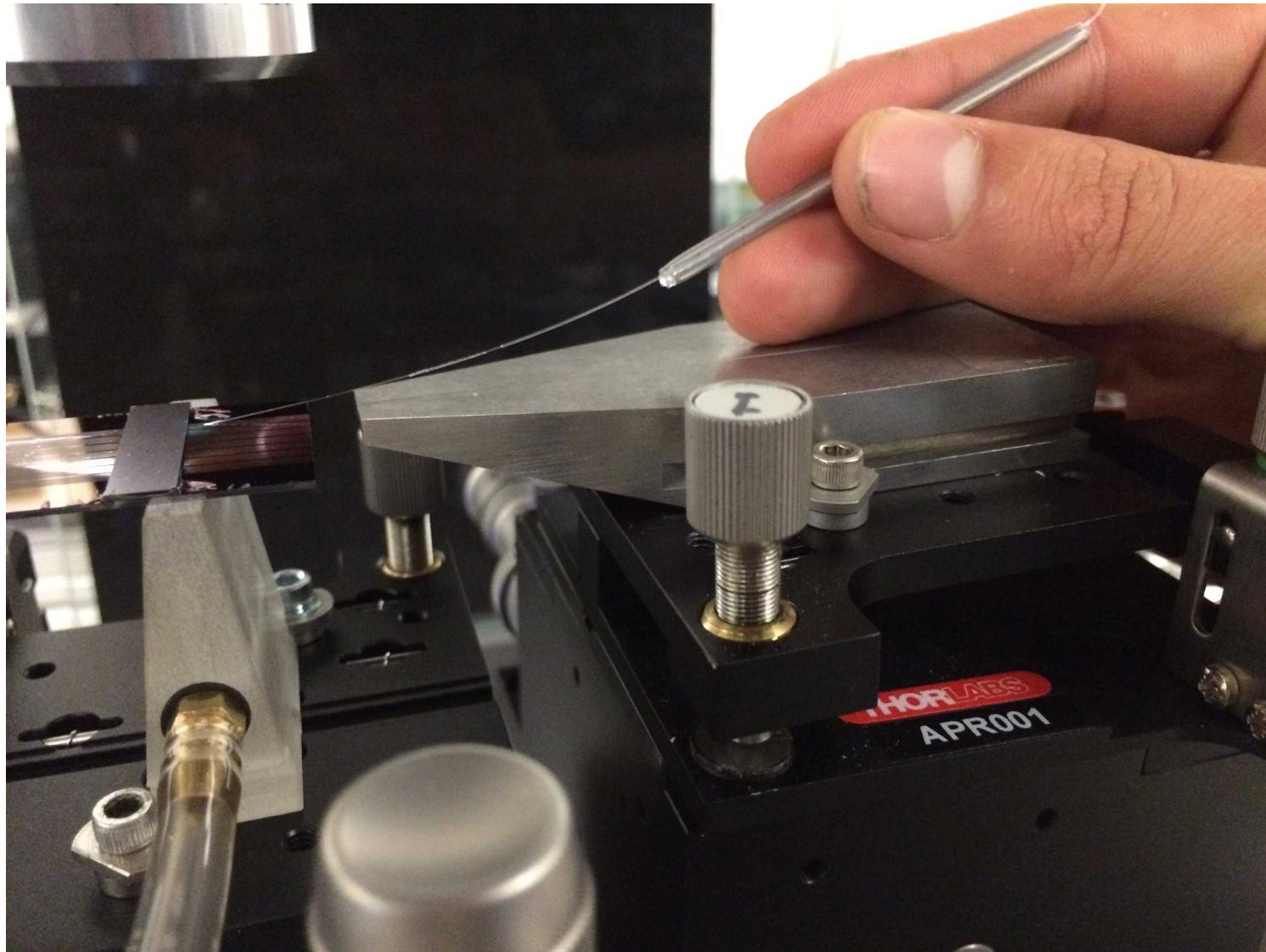
- First generation chips: adjustments will be made to process to nail down alignment.
- Typical numbers: 1.5-2 dB/facet turning one knob → **Program goal!**
- High variability due to fabrication issues – Solvable!

Have video through microscope of fiber moving in and out of socket – will be added when available

# By hand?

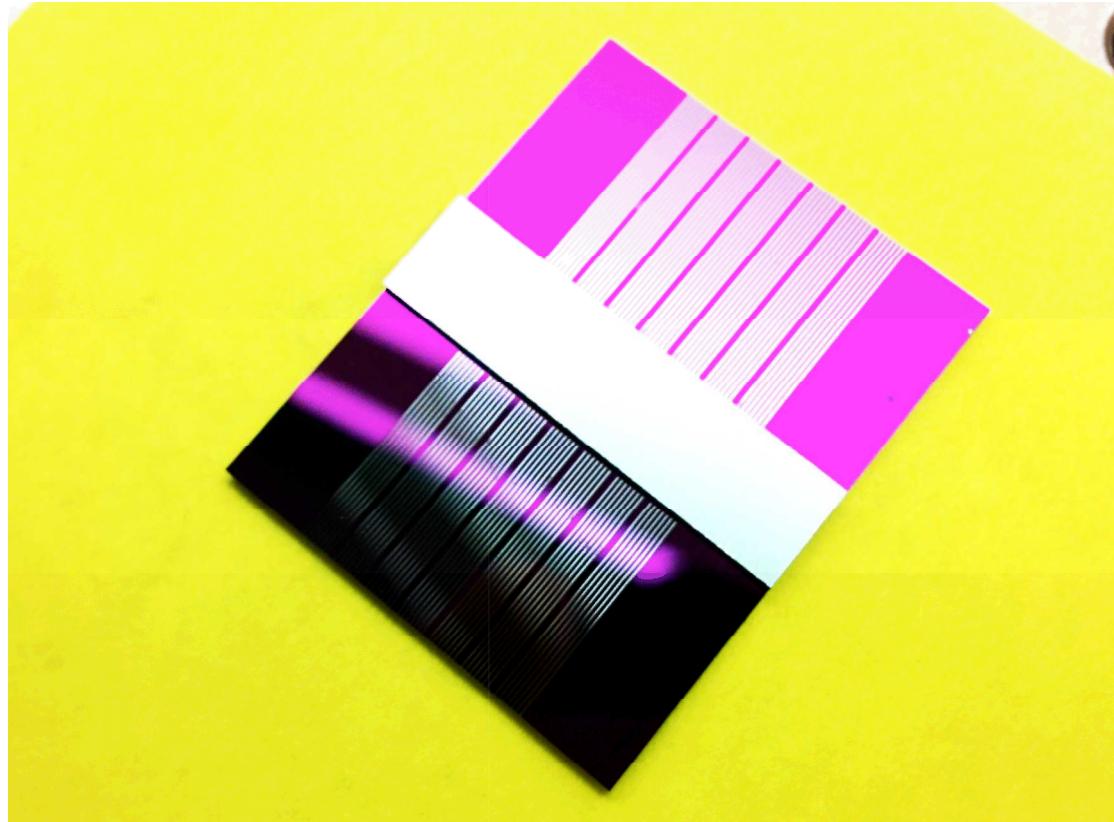


# By hand?



# Next steps...

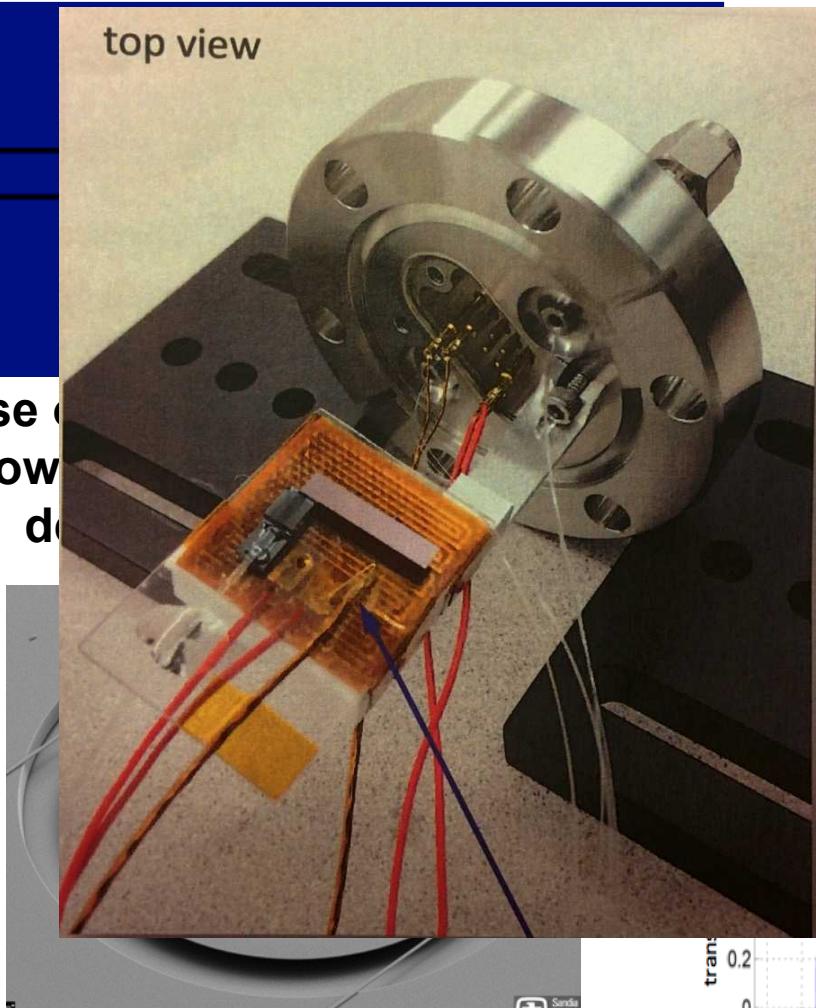
- Improve fabrication yield
- Develop spring-loaded components for stability – think FC coupler.



# Devices for UMBC

## Phase shifting micro-disks

top view



Use of  
allow  
de

